

Operation: NANO-SIM SOCKETS & 外焊 Hinge 铰链式微型识别卡座



ITEM NO.: SNO-1312 (Consumer Electronics)

(L13.0×W11.6×H1.5mm & NANO-SIM Sockets)

MEMORY-CARD-SOCKETS

Technical parameter

表面贴装 SMT

上掀操作 HINGE

精密部品 NICETY

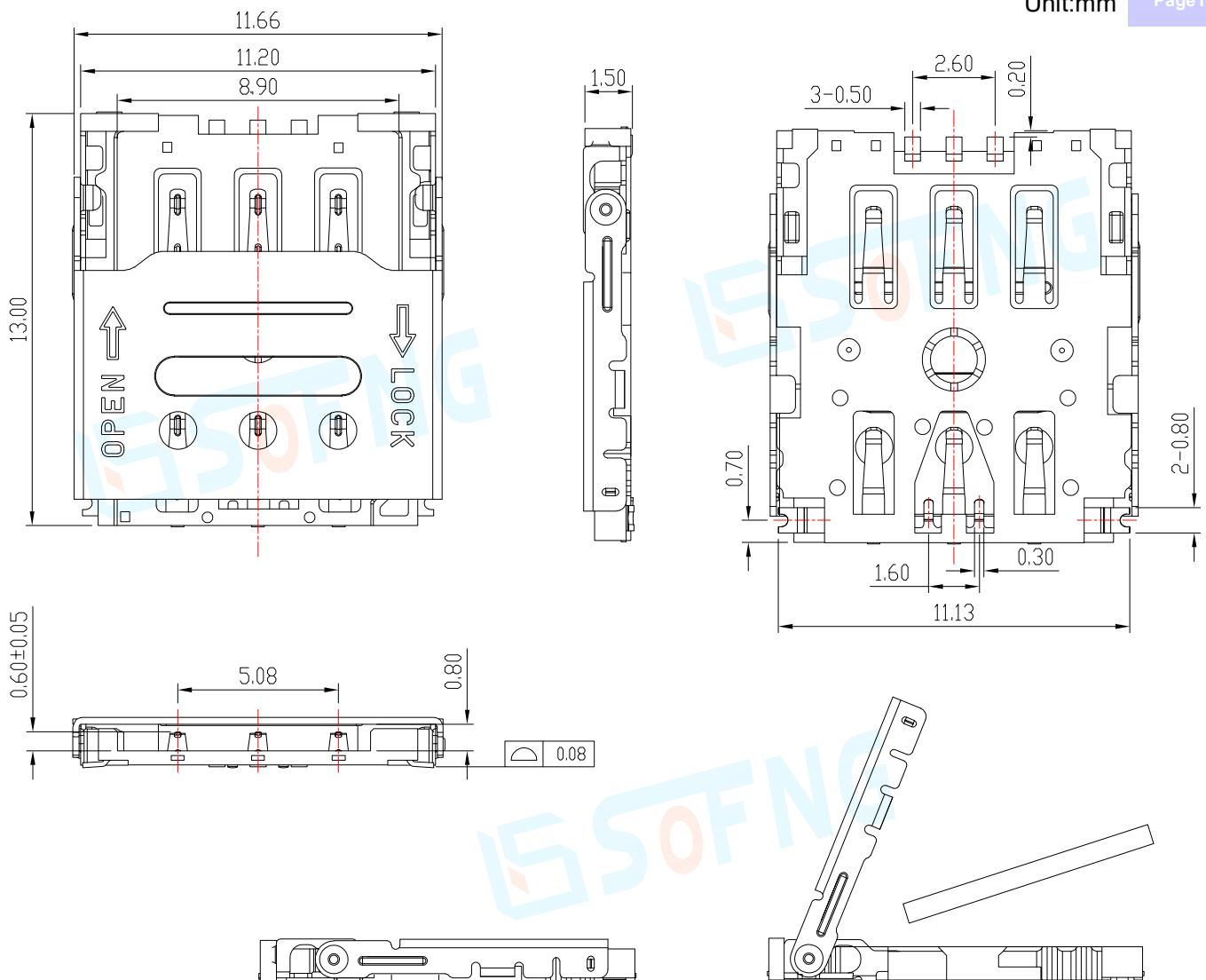
可靠 STABILIZE

適合環保 RoHS

PROJECT	LEVEL	A[better product]		B[average product]	
Electrical Properties	Contact Rating	50mA, 24V DC			
	Initial Contact Resistance	50mΩ max.		80mΩ max.	
	Insulation Resistance	100MΩ min.500V DC			
	Withstand Voltage	500V AC for 1 minute		350 V AC for 1 minut	
Durable Performance	There No Load	5,000 Cycles		3,500 Cycles	
	Rated Load	3,500 Cycles		2,500 Cycles	
	Storage temp.	-35℃～+75℃(Operating Temp:)			

Unit:mm

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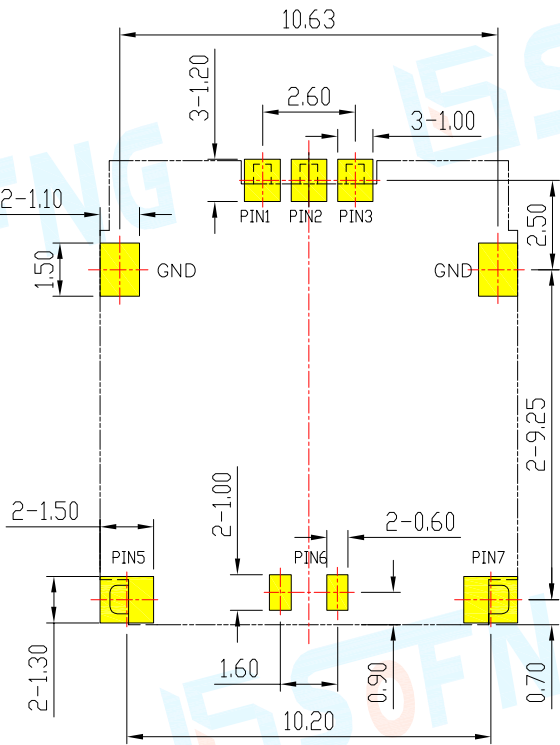


STEP 2 PUSH THE SHELL

STEP 1 INSERT NANO SIM CARD



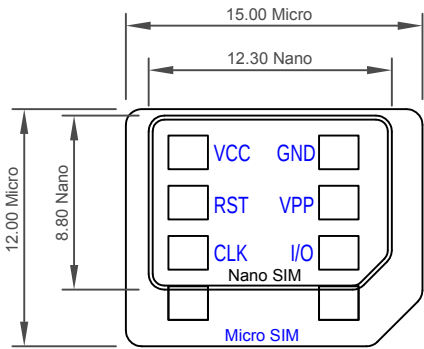
Operating Force	Inward	2.5~4.5N. (1N.=100gram-force)	Solder-ability (Max.)	IR Reflow:255°C, 5sec. Manual:350°C, 3sec.
	Exiting	2.5~4.5N. (1N.=100gram-force)		



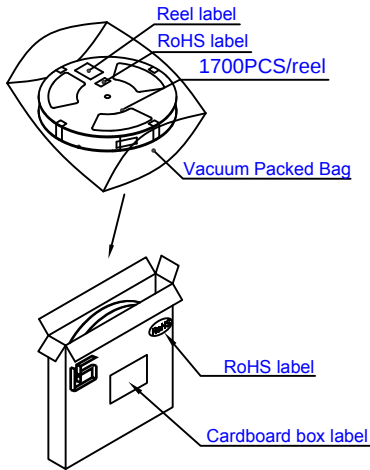
DECIMALS	ANGLES
.X :±0.20	X.° :±1.5°
.XX :±0.10	X.X° :±1.0°
.XXX :±0.05	.XXX° :±0.5°

Pin definition

SIM CARD PIN ON	NAME
PIN_1	VCC
PIN_2	RST
PIN_3	CLK
PIN_5	GND
PIN_6	VPP
PIN_7	I/O



Reference
NANO-SIM



Material declaration

NAME	MATERIAL	PLATING
① 接触端子 Terminal	C5210-EH (t=0.12mm)磷铜【镍基 Ni50u" 镀金 1u"】	G/F
② 基座 Housing	LCP 耐热塑胶 (UL94V-0) BLACK	SET
③ 上盖 Cover	SUS304-H(t=0.20mm)不锈钢【GND 焊点镀金 1u"】	AU/Ni

本品不屬於危害性廢棄物,須丟棄時可以委託回收商予以回收再生處理。Products do not belong to hazardous waste,When waste can recycling processing

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